

# Solid Tantalum Surface Mount Chip Capacitors TANTAMOUNT®, Molded Case, Low ESR



Effective September 2005, new capacitor ratings will not be added to the 593D series. All new ratings are available in the TR3 series. The TR3 series offers state-of-the-art low ESR for switch mode power supplies and DC/DC converters.

#### PERFORMANCE CHARACTERISTICS

www.vishay.com/doc?40088

Operating Temperature: - 55 °C to + 125 °C (above + 85 °C voltage derating is required)

Capacitance Range: 0.47 µF to 680 µF

Capacitance Tolerance:  $\pm$  5 %,  $\pm$  10 %,  $\pm$  20 % 100 % Surge Current Tested (C, D and E Case Sizes)

Voltage Rating: 4 V<sub>DC</sub> to 50 V<sub>DC</sub>

#### **FEATURES**

- Low ESR
- · Molded case available in five case codes



- Terminations: 100 % matte tin, standard, tin/lead available
- · High ripple current carrying capability
- Compatible with "High Volume" automatic pick and place equipment
- · Moisture sensitivity level 1
- · Compliant terminations
- Meets IEC specification QC300801/US0001 and EIA535BAAC mechanical and performance requirements
- Material categorization: For definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information/tables in this datasheet for details.

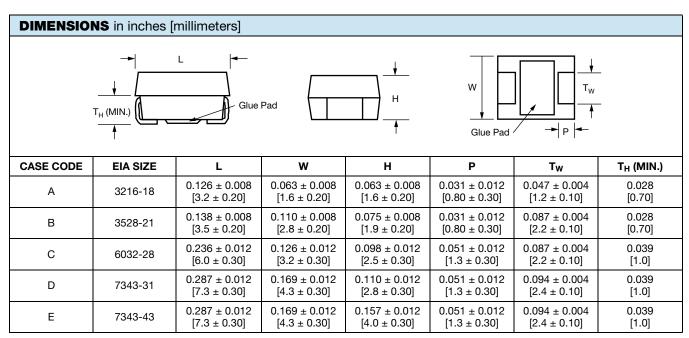
#### **APPLICATIONS**

- Industrial
- Telecom infrastructure
- · General purpose

ORD	ORDERING INFORMATION									
593D	107	Х9	010	D	2WE3					
TYPE	CAPACITANCE	CAPACITANCE TOLERANCE	DC VOLTAGE RATING AT + 85 °C	CASE CODE	TERMINATION AND PACKAGING					
	This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow	$X0 = \pm 20 \%$ $X9 = \pm 10 \%$ $X5 = \pm 5 \%$ (special order)	This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V)	See Ratings and Case Codes table	2TE3: Matte tin, 7" (178 mm) reel 2WE3: Matte tin, 13" (330 mm) reel 8T: Tin/lead, 7" (178 mm) reel 8W: Tin/lead, 13" (330 mm) reel					

#### Notes

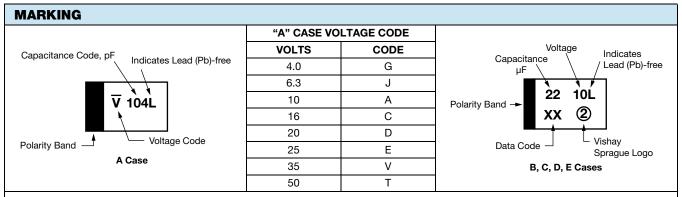
- We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size.
   Voltage substitutions will be marked with the higher voltage rating.
   Effective July 15, 2008, part numbers with solderable termination codes 2T and 2W may have either matte or tin/lead terminations.
   Codes 2TE3 and 2WE3 specify only matte tin terminations. Codes 8T and 8W specify only tin/lead terminations.
   Low ESR solid tantalum chip capacitors allow delta ESR of 1.25 times the datasheet limits after mounting.
- Dry pack is available per request, contact regional marketing.



#### Note

• Glue pad (non-conductive, part of molded case) is dedicated for glue attachment (as user option).

RATINGS	RATINGS AND CASE CODES								
μF	4 V	6.3 V	10 V	16 V	20 V	25 V	35 V	50 V	
0.47							Α		
0.68							А		
1.0				Α	Α	А	A/B	B/C	
1.5						А	B/C	B/C	
2.2					Α	A/B	B/C	C/D	
3.3				Α	Α	В	С	C/D	
4.7			Α	A/B	A/B	B/C	С	D/E	
6.8			Α	Α	В	С	C/D	D/E	
10		А	Α	A/B/C	B/C	С	C/D	D/E	
15	Α	А	A/B	B/C	B/C	C/D	D/E		
22	А	A/B	A/B/C	B/C	C/D	D	D/E		
33	A/B	A/B	B/C	B/C/D	C/D	D/E			
47	A/B	B/C	B/C/D	C/D	D/E	Е			
68	B/C	B/C	C/D	D	D/E				
100	B/C	B/C/D	C/D	D/E	Е				
150	B/C/D	C/D/E	D/E	E					
220	C/D	D/E	D/E						
330	D	D/E	E						
470	D/E	E							
680	Е								



#### Marking

Capacitor marking includes an anode (+) polarity band, capacitance in microfarads and the voltage rating. "A" Case capacitors use a letter code for the voltage and EIA capacitance code.

The Vishay Sprague® trademark is included if space permits. Capacitors rated at 6.3 V are marked 6 V.

A manufacturing date code is marked on all capacitors.

Capacitors may bear a different marking scheme if a part with more extensive screening is substituted. These would include, for example, "R" for low ESR series (TR3) or "P" for professional series (TP3).

Call the factory for further explanation.

STANDARD	RATINGS					
CAPACITANCE (μF)	CASE CODE	PART NUMBER	MAX. DCL AT + 25 °C (μA)	MAX. DF AT + 25 °C 120 Hz (%)	MAX. ESR AT + 25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I <sub>RMS</sub> (A)
		4 V <sub>DC</sub> AT + 85 °	C; 2.7 V <sub>DC</sub> AT + 12	5 °C		
15	Α	593D156(1)004A(2)	0.6	6	1.500	0.22
22	Α	593D226(1)004A(2)	0.9	6	1.500	0.22
33	Α	593D336(1)004A(2)	1.3	6	1.500	0.22
33	В	593D336(1)004B(2)	1.3	6	0.500	0.41
47	Α	593D476(1)004A(2)	1.9	14	0.800	0.31
47	В	593D476(1)004B(2)	1.9	6	0.500	0.41
68	В	593D686(1)004B(2)	2.7	6	0.500	0.41
68	С	593D686(1)004C(2)	2.7	6	0.275	0.63
100	В	593D107(1)004B(2)	4.0	8	0.450	0.43
100	С	593D107(1)004C(2)	4.0	6	0.225	0.66
150	В	593D157(1)004B(2)	6.0	14	0.500	0.41
150	С	593D157(1)004C(2)	6.0	12	0.250	0.66
150	D	593D157(1)004D(2)	6.0	8	0.150	1.00
220	С	593D227(1)004C(2)	8.8	8	0.200	0.74
220	D	593D227(1)004D(2)	8.8	8	0.150	1.00
330	D	593D337(1)004D(2)	13.2	8	0.150	1.00
470	D	593D477(1)004D(2)	18.8	10	0.125	1.10
470	Е	593D477(1)004E(2)	18.8	10	0.100	1.28
680	Е	593D687(1)004E(2)	27.2	12	0.100	1.28
		6.3 V <sub>DC</sub> AT + 8	5 °C; 4 V <sub>DC</sub> AT 125	°C		
10	Α	593D106(1)6R3A(2)	0.6	6	2.000	0.19
15	Α	593D156(1)6R3A(2)	0.9	6	2.000	0.19
22	Α	593D226(1)6R3A(2)	1.3	6	2.000	0.19
22	В	593D226(1)6R3B(2)	1.3	6	0.600	0.38
33	Α	593D336(1)6R3A(2)	2.0	14	0.800	0.31

- Part number definitions:
  - (1) Tolerance: X0, X9, X5
  - (2) Terminations and packaging: 2TE3, 2WE3, 8T, 8W



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STANDARD	RATINGS					
CAPACITANCE (μF)	CASE CODE	PART NUMBER	MAX. DCL AT + 25 °C (μΑ)	MAX. DF AT + 25 °C 120 Hz (%)	MAX. ESR AT + 25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I <sub>RMS</sub> (A)
		6.3 V <sub>DC</sub> AT + 8	85 °C; 4 V <sub>DC</sub> AT 125	°C		
33	В	593D336(1)6R3B(2)	2.0	6	0.600	0.38
47	В	593D476(1)6R3B(2)	2.8	6	0.550	0.39
47	С	593D476(1)6R3C(2)	2.8	6	0.300	0.61
68	В	593D686(1)6R3B(2)	4.1	6	0.550	0.39
68	С	593D686(1)6R3C(2)	4.1	6	0.275	0.63
100	В	593D107(1)6R3B(2)	6.0	15	0.500	0.41
100	С	593D107(1)6R3C(2)	6.0	6	0.250	0.66
100	D	593D107(1)6R3D(2)	6.0	6	0.140	1.04
150	С	593D157(1)6R3C(2)	9.0	8	0.200	0.74
150	D	593D157(1)6R3D(2)	9.0	8	0.125	1.10
150	Е	593D157(1)6R3E(2)	9.0	8	0.100	1.28
220	D	593D227(1)6R3D(2)	13.2	8	0.100	1.22
220	E	593D227(1)6R3E(2)	13.2	8	0.100	1.28
330	D	593D337(1)6R3D(2)	19.8	8	0.125	1.10
330	E	593D337(1)6R3E(2)	19.8	8	0.100	1.28
470	E	593D477(1)6R3E(2)	28.2	10	0.100	1.28
		10 V <sub>DC</sub> AT + 8	85 °C; 7 V <sub>DC</sub> AT 125	°C		
4.7	Α	593D475(1)010A(2)	0.5	6	3.000	0.16
6.8	Α	593D685(1)010A(2)	0.7	6	3.000	0.16
10	Α	593D106(1)010A(2)	1.0	6	2.000	0.19
15	Α	593D156(1)010A(2)	1.5	6	2.000	0.19
15	В	593D156(1)010B(2)	1.5	6	0.700	0.35
22	Α	593D226(1)010A(2)	2.2	8	1.500	0.22
22	В	593D226(1)010B(2)	2.2	6	0.700	0.35
22	С	593D226(1)010C(2)	2.2	6	0.345	0.56
33	В	593D336(1)010B(2)	3.3	6	0.600	0.38
33	С	593D336(1)010C(2)	3.3	6	0.300	0.61
47	В	593D476(1)010B(2)	4.7	6	0.600	0.38
47	С	593D476(1)010C(2)	4.7	6	0.300	0.61
47	D	593D476(1)010D(2)	4.7	6	0.200	0.87
68	С	593D686(1)010C(2)	6.8	6	0.275	0.63
68	D	593D686(1)010D(2)	6.8	6	0.150	1.00
100	С	593D107(1)010C(2)	10.0	8	0.200	0.74
100	D	593D107(1)010D(2)	10.0	6	0.100	1.22
150	D	593D157(1)010D(2)	15.0	8	0.100	1.22
150	Е	593D157(1)010E(2)	15.0	8	0.100	1.28
220	D	593D227(1)010D(2)	22.0	8	0.125	1.10
220	Е	593D227(1)010E(2)	22.0	8	0.100	1.28
330	E	593D337(1)010E(2)	33.0	10	0.100	1.28

- Part number definitions:
  - (1) Tolerance: X0, X9, X5
  - (2) Terminations and packaging: 2TE3, 2WE3, 8T, 8W



CAPACITANCE (µF)	CASE CODE	PART NUMBER	MAX. DCL AT + 25 °C	MAX. DF AT + 25 °C 120 Hz	MAX. ESR AT + 25 °C 100 kHz	MAX. RIPPLE 100 kHz I <sub>RMS</sub>
(μι )			(μΑ)	(%)	(Ω)	(A)
		16 V <sub>DC</sub> AT + 85	°C; 10 V <sub>DC</sub> AT + 12	5 °C		
1.0	Α	593D105(1)016A(2)	0.5	4	5.500	0.12
3.3	Α	593D335(1)016A(2)	0.5	6	3.500	0.15
4.7	Α	593D475(1)016A(2)	0.8	6	2.500	0.17
4.7	В	593D475(1)016B(2)	0.8	6	1.500	0.24
6.8	Α	593D685(1)016A(2)	1.1	6	3.000	0.16
10	Α	593D106(1)016A(2)	1.6	6	1.700	0.21
10	В	593D106(1)016B(2)	1.6	6	0.800	0.33
10	С	593D106(1)016C(2)	1.6	6	0.450	0.49
15	В	593D156(1)016B(2)	2.4	6	0.800	0.33
15	С	593D156(1)016C(2)	2.4	6	0.400	0.52
22	В	593D226(1)016B(2)	3.5	6	0.700	0.35
22	С	593D226(1)016C(2)	3.5	6	0.350	0.56
33	В	593D336(1)016B(2)	5.3	6	0.700	0.35
33	С	593D336(1)016C(2)	5.3	6	0.300	0.61
33	D	593D336(1)016D(2)	4.2	4	0.225	0.82
47	С	593D476(1)016C(2)	7.5	6	0.300	0.61
47	D	593D476(1)016D(2)	7.5	6	0.150	1.00
68	D	593D686(1)016D(2)	10.9	6	0.150	1.00
100	D	593D107(1)016D(2)	16.0	8	0.125	1.10
100	Е	593D107(1)016E(2)	16.0	8	0.100	1.28
150	Е	593D157(1)016E(2)	24.0	8	0.100	1.28
			°C; 13 V <sub>DC</sub> AT + 12	.5 °C		
1.0	A	593D105(1)020A(2)	0.5	4	5.500	0.12
2.2	Α	593D225(1)020A(2)	0.5	6	4.000	0.14
3.3	Α	593D335(1)020A(2)	0.7	6	4.000	0.14
4.7	Α	593D475(1)020A(2)	0.9	6	3.500	0.15
4.7	В	593D475(1)020B(2)	0.9	6	1.000	0.29
6.8	В	593D685(1)020B(2)	1.4	6	1.000	0.29
10	В	593D106(1)020B(2)	2.0	6	1.000	0.29
10	С	593D106(1)020C(2)	2.0	6	0.450	0.49
15	В	593D156(1)020B(2)	3.0	6	1.000	0.29
15	С	593D156(1)020C(2)	3.0	6	0.400	0.52
22	С	593D226(1)020C(2)	4.4	6	0.375	0.54
22	D	593D226(1)020D(2)	3.5	4	0.225	0.82
33	С	593D336(1)020C(2)	6.6	6	0.350	0.56
33	D	593D336(1)020D(2)	6.6	6	0.200	0.87
47	D	593D476(1)020D(2)	9.4	6	0.200	0.87
47	E	593D476(1)020E(2)	7.5	4	0.150	1.05
68	D	593D686(1)020D(2)	13.6	6	0.175	0.93
68	E	593D686(1)020E(2)	13.6	6	0.150	1.05
100	E	593D107(1)020E(2)	20.0	8	0.150	1.05

- Part number definitions:
  - (1) Tolerance: X0, X9, X5
  - (2) Terminations and packaging: 2TE3, 2WE3, 8T, 8W



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CAPACITANCE (µF)	CASE CODE	PART NUMBER	MAX. DCL AT + 25 °C (μA)	MAX. DF AT + 25 °C 120 Hz (%)	MAX. ESR AT + 25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I <sub>RMS</sub> (A)
		25 V <sub>DC</sub> AT + 85	°C; 17 V <sub>DC</sub> AT + 12		()	. ,
1.0	Α	593D105(1)025A(2)	0.5	4	4.000	0.14
1.5	Α	593D155(1)025A(2)	0.5	6	4.000	0.14
2.2	Α	593D225(1)025A(2)	0.6	6	4.000	0.14
2.2	В	593D225(1)025B(2)	0.6	6	1.500	0.24
3.3	В	593D335(1)025B(2)	0.8	6	1.500	0.24
4.7	В	593D475(1)025B(2)	1.2	6	1.500	0.24
4.7	С	593D475(1)025C(2)	1.2	6	0.525	0.46
6.8	С	593D685(1)025C(2)	1.7	6	0.500	0.47
10	С	593D106(1)025C(2)	2.5	6	0.450	0.49
15	С	593D156(1)025C(2)	3.8	6	0.425	0.51
15	D	593D156(1)025D(2)	3.8	6	0.250	0.77
22	D	593D226(1)025D(2)	5.5	6	0.200	0.87
33	D	593D336(1)025D(2)	8.3	6	0.200	0.87
33	E	593D336(1)025E(2)	8.3	6	0.200	0.91
47	Е	593D476(1)025E(2)	11.8	6	0.200	0.91
		35 V <sub>DC</sub> AT + 85	°C; 23 V <sub>DC</sub> AT + 12	5 °C		
0.47	Α	593D474(1)035A(2)	0.5	4	4.000	0.14
0.68	Α	593D684(1)035A(2)	0.5	4	4.000	0.14
1.0	Α	593D105(1)035A(2)	0.5	4	4.000	0.14
1.0	В	593D105(1)035B(2)	0.5	4	2.000	0.21
1.5	В	593D155(1)035B(2)	0.5	6	2.000	0.21
1.5	С	593D155(1)035C(2)	0.5	6	0.900	0.35
2.2	В	593D225(1)035B(2)	0.8	6	2.000	0.21
2.2	С	593D225(1)035C(2)	0.8	6	0.900	0.40
3.3	С	593D335(1)035C(2)	1.2	6	0.700	0.45
4.7	С	593D475(1)035C(2)	1.6	6	0.500	0.47
6.8	С	593D685(1)035C(2)	2.4	6	0.475	0.48
6.8	D	593D685(1)035D(2)	2.4	6	0.300	0.71
10	С	593D106(1)035C(2)	3.5	6	0.450	0.49
10	D	593D106(1)035D(2)	3.5	6	0.300	0.71
15	D	593D156(1)035D(2)	5.3	6	0.300	0.71
15	Е	593D156(1)035E(2)	5.3	6	0.300	0.74
22	D	593D226(1)035D(2)	7.7	6	0.300	0.71
22	Е	593D226(1)035E(2)	7.7	6	0.275	0.77
		50 V <sub>DC</sub> AT + 85	°C; 33 V <sub>DC</sub> AT + 12	5 °C		
1.0	В	593D105(1)050B(2)	0.5	4	2.000	0.21
1.0	С	593D105(1)050C(2)	0.5	4	1.600	0.26
1.5	В	593D155(1)050B(2)	0.8	6	2.000	0.21
1.5	С	593D155(1)050C(2)	0.8	6	1.500	0.27
2.2	С	593D225(1)050C(2)	1.1	6	1.500	0.27
2.2	D	593D225(1)050D(2)	1.1	6	0.800	0.43
3.3	С	593D335(1)050C(2)	1.7	6	1.500	0.27
3.3	D	593D335(1)050D(2)	1.7	6	0.800	0.43
4.7	D	593D475(1)050D(2)	2.4	6	0.600	0.50
4.7	Е	593D475(1)050E(2)	1.9	6	0.600	0.50
6.8	D	593D685(1)050D(2)	3.4	6	0.600	0.50
6.8	Е	593D685(1)050E(2)	3.4	6	0.550	0.55
10	D	593D106(1)050D(2)	5.0	6	0.550	0.52
10	Е	593D106(1)050E(2)	5.0	6	0.550	0.55

- Part number definitions:
  - (1) Tolerance: X0, X9, X5
  - (2) Terminations and packaging: 2TE3, 2WE3, 8T, 8W



STANDARD CONDITIONS. FOR EXAMPLE: OUTPUT FILTERS	
Capacitor Voltage Rating	Operating Voltage
4.0	2.5
6.3	3.6
10	6.0
16	10
20	12
25	15
35	24
50	28
EVERE CONDITIONS. FOR EXAMPLE: INPUT FILTERS	
Capacitor Voltage Rating	Operating Voltage
4.0	2.5
6.3	3.3
10	5.0
16	8.0
20	10
25	12
35	15
50	24

POWER DISSIPATION	
CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT + 25 °C (W) IN FREE AIR
A	0.075
В	0.085
С	0.110
D	0.150
E	0.165

STANDARD PACKAGING QUANTITY						
CASE CODE	UNITS PER REEL					
CASE CODE	7" REEL	13" REEL				
A	2000	9000				
В	2000	8000				
С	500	3000				
D	500	2500				
E	400	1500				

PRODUCT INFORMATION					
Guide for Molded Tantalum Capacitors					
Pad Dimensions	www.vishay.com/doc?40074				
Packaging Dimensions					
Moisture Sensitivity	www.vishay.com/doc?40135				
SELECTOR GUIDES	·				
Solid Tantalum Selector Guide	www.vishay.com/doc?49053				
Solid Tantalum Chip Capacitors	www.vishay.com/doc?40091				
FAQ					
Frequently Asked Questions	www.vishay.com/doc?40110				



# **Guide for Molded Tantalum Capacitors**

#### INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum/tantalum oxide/manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

#### THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve"metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance/volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance/volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS				
DIELECTRIC	e DIELECTRIC CONSTANT			
Air or Vacuum	1.0			
Paper	2.0 to 6.0			
Plastic	2.1 to 6.0			
Mineral Oil	2.2 to 2.3			
Silicone Oil	2.7 to 2.8			
Quartz	3.8 to 4.4			
Glass	4.8 to 8.0			
Porcelain	5.1 to 5.9			
Mica	5.4 to 8.7			
Aluminum Oxide	8.4			
Tantalum Pentoxide	26			
Ceramic	12 to 400K			

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = Capacitance

e = Dielectric constant

A = Surface area of the dielectric

t = Thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.



#### **SOLID ELECTROLYTE TANTALUM CAPACITORS**

Solid electrolyte capacitors contain manganese dioxide, which is formed on the tantalum pentoxide dielectric layer by impregnating the pellet with a solution of manganous nitrate. The pellet is then heated in an oven, and the manganous nitrate is converted to manganese dioxide.

The pellet is next coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the pellet and the Leadframe.

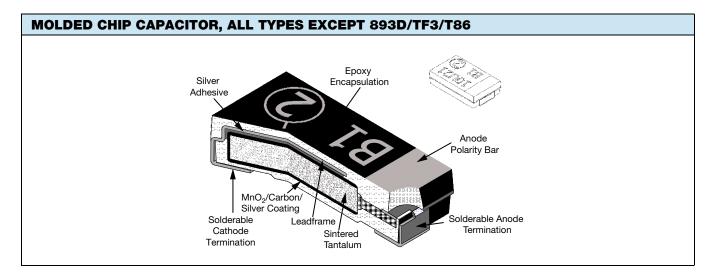
Molded Chip tantalum capacitor encases the element in plastic resins, such as epoxy materials. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for consumer and commercial electronics with the added feature of low cost

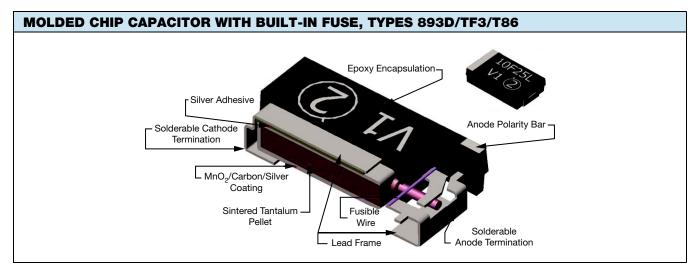
Surface mount designs of "Solid Tantalum" capacitors use lead frames or lead frameless designs as shown in the accompanying drawings.

# TANTALUM CAPACITORS FOR ALL DESIGN CONSIDERATIONS

Solid electrolyte designs are the least expensive for a given rating and are used in many applications where their very small size for a given unit of capacitance is of importance. They will typically withstand up to about 10 % of the rated DC working voltage in a reverse direction. Also important are their good low temperature performance characteristics and freedom from corrosive electrolytes.

Vishay Sprague patented the original solid electrolyte capacitors and was the first to market them in 1956. Vishay Sprague has the broadest line of tantalum capacitors and has continued its position of leadership in this field. Data sheets covering the various types and styles of Vishay Sprague capacitors for consumer and entertainment electronics, industry, and military applications are available where detailed performance characteristics must be specified.









#### **COMMERCIAL PRODUCTS**

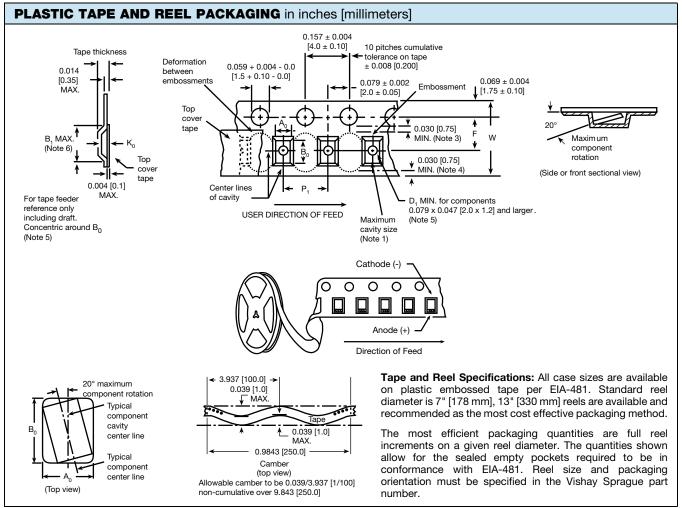
SOLID TANTALUM CAPACITORS - MOLDED CASE								
SERIES	293D	793DE-793DX- CTC3-CTC4	593D	TR3	TP3	TL3		
PRODUCT IMAGE	The last line line		100000000			18 0 15 S		
TYPE		Surface m	ount Tantamoun	r®, molded case				
FEATURES	Standard industrial grade	CECC approved	Low ESR	Low ESR	High performance, automotive grade	Very low DCL		
TEMPERATURE RANGE		- 55 °C to + 125 °C						
CAPACITANCE RANGE	0.1 μF to 1000 μF	0.1 μF to 100 μF	1 μF to 470 μF	0.47 μF to 1000 μF	0.1 μF to 470 μF	0.1 μF to 470 μF		
VOLTAGE RANGE	4 V to 63 V	4 V to 50 V	4 V to 50 V	4 V to 63 V	4 V to 50 V	4 V to 50 V		
CAPACITANCE TOLERANCE			± 10	%, ± 20 %				
LEAKAGE CURRENT	0.01 CV or 0.5 μA, whichever is greater							
DISSIPATION FACTOR	4 % to 30 %	4 % to 6 %	4 % to 15 %	4 % to 30 %	4 % to 15 %	4 % to 15 %		
CASE CODES	A, B, C, D, E, V	A, B, C, D	A, B, C, D, E	A, B, C, D, E, V, W	A, B, C, D, E	A, B, C, D, E		
TERMINATION		10	00 % matte tin st	andard, tin/lead availab	le			

SOLID TANTAL	SOLID TANTALUM CAPACITORS - MOLDED CASE				
SERIES	TH3	TH4	TH5	893D	TF3
PRODUCT IMAGE	1528	The same	Tons 1	THE SUL	THE SOL
TYPE		Surface	mount Tantamount®, m	olded case	
FEATURES	High temperature + 150 °C, automotive grade	High temperature + 175 °C, automotive grade	Very high temperature + 200 °C	Built-in fuse	Built-in fuse, low ESR
TEMPERATURE RANGE	- 55 °C to + 150 °C	- 55 °C to + 150 °C   - 55 °C to + 175 °C   - 55 °C to + 200 °C   - 55 °C to + 125 °C			) + 125 °C
CAPACITANCE RANGE	0.33 μF to 220 μF	10 μF to 47 μF	10 μF	0.47 μF to 680 μF	0.47 μF to 470 μF
VOLTAGE RANGE	6.3 V to 50 V	6.3 V to 16 V	21 V	4 V to 50 V	4 V to 50 V
CAPACITANCE TOLERANCE	± 10 %, ± 20 %				
LEAKAGE CURRENT	0.01 CV or 0.5 μA, whichever is greater				
DISSIPATION FACTOR	4 % to 8 %	4.5 % to 6 %	6 %	6 % to 15 %	6 % to 15 %
CASE CODES	A, B, C, D, E	B, C	Е	C, D, E	C, D, E
TERMINATION	100 % matte tin standard, tin/lead and gold plated available	100 % matte tin	Gold plated	100 % matte tin stand	dard, tin/lead available



#### **HIGH RELIABILITY PRODUCTS**

SOLID TANTALUM CAPACITORS - MOLDED CASE					
SERIES	T83	T86	CWR11	04053	95158
PRODUCT IMAGE	17716 10 3				
TYPE		, molded case, . COTS	Tan	TAMOUNT <sup>®</sup> , molded of DLA approved	case,
FEATURES	High reliability, standard and low ESR	High reliability, built-in fuse, standard and low ESR	MIL-PRF-55365/8 qualified	Built-in fuse	Low ESR
TEMPERATURE RANGE			- 55 °C to + 125 °C		
CAPACITANCE RANGE	0.1 μF to 470 μF	0.47 μF to 330 μF	0.1 μF to 100 μF	0.47 μF to 470 μF	4.7 μF to 220 μF
VOLTAGE RANGE	4 V to 63 V		4 V to	50 V	
CAPACITANCE TOLERANCE	± 10 %	± 5 %, ± 10 %, ± 20 % ± 10 %, ± 20 %			± 10 %, ± 20 %
LEAKAGE CURRENT		0.01 CV or 0.5 μA, whichever is greater			
DISSIPATION FACTOR	4 % to 15 %	6 % to 16 %	4 % to 6 %	4 % to 8 %	4 % to 12 %
CASE CODES	A, B, C, D, E	C, D, E	A, B, C, D	C, D, E	C, D, E
TERMINATION		e tin; tin/lead; older fused	Tin/lead; tin/lead solder fused	Tin/lead solder plated	Tin/lead solder plated; gold plated



#### Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only.
- (1) A<sub>0</sub>, B<sub>0</sub>, K<sub>0</sub>, are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A<sub>0</sub>, B<sub>0</sub>, K<sub>0</sub>) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum.
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less.
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less.
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossement. Dimensions of embossement location shall be applied independent of each other.
- (6) B<sub>1</sub> dimension is a reference dimension tape feeder clearance only.

CASE CODE	TAPE SIZE	B <sub>1</sub> (MAX.)	D <sub>1</sub> (MIN.)	F	K <sub>0</sub> (MAX.)	P <sub>1</sub>	w
293D - 593	BD - 893D - '	TR3 - TH3 - TF3	- TP3 - 793DE/79	3DX/CTC3/CTC4			
Α	8 mm	0.165	0.039	0.138 ± 0.002	0.094	0.157 ± 0.004	0.315 ± 0.012
В	0 111111	[4.2]	[1.0]	$[3.5 \pm 0.05]$	[2.4]	$[4.0 \pm 1.0]$	$[8.0 \pm 0.30]$
С							
D		0.00	0.050	0.017 - 0.00	0.477	0.045 - 0.004	0.470 + 0.040
E	12 mm	0.32 [8.2]	0.059 [1.5]	0.217 ± 0.00 [5.5 ± 0.05]	0.177 [4.5]	0.315 ± 0.004 [8.0 ± 1.0]	0.472 ± 0.012 [12.0 ± 0.30]
V		[0.2]	[1.0]	[5.5 ± 6.65]	[4.0]	[0.0 ± 1.0]	[12.0 ± 0.30]
W							

Revision: 27-Jun-12 33 Document Number: 40074



# Capacitors should withstand Reflow profile as per J-STD-020 standard To Max. ramp-down rate = 3 °C/s Max. ramp-down rate = 6 °C/s To max. Preheat area Time 25 °C to peak Time (s) PROFILE FEATURE SnPb EUTECTIC ASSEMBLY LEAD (Pb)-FREE ASSEMBLY

PROFILE FEATURE	SnPb EUTECTIC ASSEMBLY	LEAD (Pb)-FREE ASSEMBLY
Preheat/soak		
Temperature min. (T <sub>s min.</sub> )	100 °C	150 °C
Temperature max. (T <sub>s max.</sub> )	150 °C	200 °C
Time (t <sub>s</sub> ) from (T <sub>s min.</sub> to T <sub>s max.</sub> )	60 s to 120 s	60 s to 120 s
Ramp-up		
Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )	3 °C/s max.	3 °C/s max.
Liquidous temperature (T <sub>L</sub> )	183 °C	217 °C
Time (t <sub>L</sub> ) maintained above T <sub>L</sub>	60 s to 150 s	60 s to 150 s
Peak package body temperature (Tp)	Depends on case size - see table below	
Time (t <sub>p</sub> ) within 5 °C of the specified classification temperature (T <sub>C</sub> )	20 s	30 s
Time 25 °C to peak temperature	6 min max.	8 min max.
Ramp-down		
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 °C/s max.	6 °C/s max.

PEAK PACKAGE BODY TEMPERATURE (Tp)				
CASE CODE	PEAK PACKAGE BODY TEMPERATURE (Tp)			
CASE CODE	SnPb EUTECTIC PROCESS	LEAD (Pb)-FREE PROCESS		
A, B, C, V	235 °C	260 °C		
D, E, W	220 °C	250 °C		

# PAD DIMENSIONS in inches [millimeters]

CASE CODE	A (MIN.)	B (NOM.)	C (NOM.)	D (NOM.)
293D - 593D - 893D - TR	3 - TL3 - TH3 - TH4 - TH5 -	TF3 - TP3 - 793DE/793DX/0	CTC3/CTC4 - T83 - T86 - C	WR11 - 95158 - 04053
Α	0.071 [1.80]	0.067 [1.70]	0.053 [1.35]	0.187 [4.75]
В	0.118 [3.00]	0.071 [1.80]	0.065 [1.65]	0.207 [5.25]
С	0.118 [3.00]	0.094 [2.40]	0.118 [3.00]	0.307 [7.80]
D	0.157 [4.00]	0.098 [2.50]	0.150 [3.80]	0.346 [8.80]
E	0.157 [4.00]	0.098 [2.50]	0.150 [3.80]	0.346 [8.80]
V	0.157 [4.00]	0.098 [2.50]	0.150 [3.80]	0.346 [8.80]
W	0.185 [4.70]	0.098 [2.50]	0.150 [3.80]	0.346 [8.80]

Revision: 27-Jun-12 34 Document Number: 40074

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#### Vishay Sprague

#### **GUIDE TO APPLICATION**

 AC Ripple Current: The maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = Power dissipation in W at + 25 °C as given in the tables in the product datasheets (Power Dissipation).

R<sub>ESR</sub> = The capacitor equivalent series resistance at the specified frequency

2. **AC Ripple Voltage:** The maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

or, from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

where.

P = Power dissipation in W at + 25 °C as given in the tables in the product datasheets (Power Dissipation).

R<sub>ESR</sub> = The capacitor equivalent series resistance at the specified frequency

Z = The capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at + 25 °C.
- Reverse Voltage: Solid tantalum capacitors are not intended for use with reverse voltage applied. However, they have been shown to be capable of withstanding momentary reverse voltage peaks of up to 10 % of the DC rating at 25 °C and 5 % of the DC rating at + 85 °C.
- 4. Temperature Derating: If these capacitors are to be operated at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors as shown:

TEMPERATURE	DERATING FACTOR
+ 25 °C	1.0
+ 85 °C	0.9
+ 125 °C	0.4

5. **Power Dissipation:** Power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I<sub>RMS</sub> value be established when calculating permissible operating levels. (Power dissipation calculated using + 25 °C temperature rise).

6. **Printed Circuit Board Materials:** Molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelanized steel).

#### 7. Attachment:

- 7.1 **Solder Paste:** The recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.
- 7.2 **Soldering:** Capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering, and hot plate methods. The soldering profile charts show recommended time/temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor.
- 7.2.1 Backward and Forward Compatibility: Capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
- 8. Cleaning (Flux Removal) After Soldering: Molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC/ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/I at 40 kHz for 2 min.
- 9. Recommended Mounting Pad Geometries: Proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and/or circuit board design.

# **Typical Performance Characteristics**

Vishay Sprague

# **Typical Performance Characteristics Tantalum Capacitors**

CAPACITOR ELECTRICAL PERFORMANCE CHARACTERISTICS				
ITEM	PERFORMANCE CHARACTERISTICS			
Category temperature range	- 55 °C to + 85 °C (to + 1	25 °C with voltage derating	g)	
Capacitance tolerance	± 20 %, ± 10 % (at 120 H	Hz) 2 V <sub>RMS</sub> (max.) at + 25 °C	C using a capacitance bridg	е
Dissipation factor	Limit per Standard Rating	gs table. Tested via bridge	method, at 25 °C, 120 Hz	
ESR	Limit per Standard Rating	gs table. Tested via bridge	method, at 25 °C, 100 kHz	
Leakage current	1 kΩ resistor in series wit 0.5 μA, whichever is great	h the capacitor under test,	itors for 5 min using a steal leakage current at 25 °C is current varies with temperator.	not more than 0.01 CV or
Capacitance change by temperature		For capacitance value > 300 μF + 12 % max. (at + 125 °C) + 20 % max. (at + 125 °C) + 10 % max. (at + 85 °C) + 15 % max. (at + 85 °C) - 10 % max. (at - 55 °C) - 15 % max. (at - 55 °C)		
Reverse voltage	Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at + 25 °C 5 % of the DC rating at + 85 °C Vishay does not recommend intentional or repetitive application of reverse voltage			
Temperature derating	If capacitors are to be used at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors:  1.0 at + 25 °C  0.9 at + 85 °C  0.4 at + 125 °C			
Operating temperature	+ 85	5 °C	+ 12	5 °C
	RATED VOLTAGE (V)	SURGE VOLTAGE (V)	RATED VOLTAGE (V)	SURGE VOLTAGE (V)
	4	5.2	2.7	3.4
	6.3	8	4	5
	10	13	7	8
	16	20	10	12
	20 26 13			
	25 32 17			
	35 46 23			28
50 65 33			33	40
	50 (1)	60	33	40
	63	76	42	50

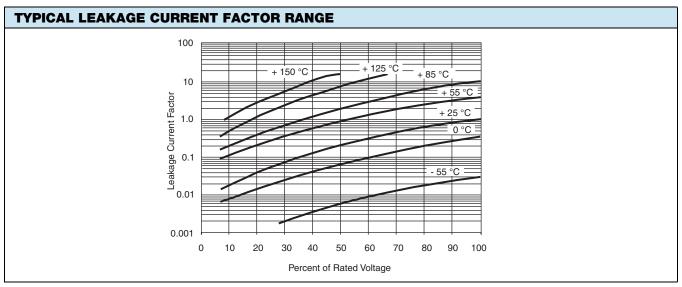
#### Notes

All information presented in this document reflects typical performance characteristics

<sup>(1)</sup> Capacitance values 15 µF and higher

# **Typical Performance Characteristics**

Vishay Sprague



#### **Notes**

- At + 25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
- At + 85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At + 125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table.

CAPACITOR PE	CAPACITOR PERFORMANCE CHARACTERISTICS				
ITEM	PERFORMANCE CHARACTERISTICS				
Surge voltage	Post application of surge voltage (as specified in the table above) in series with a 33 Ω resistor at the rate of 30 s ON, 30 s OFF, for 1000 successive test cycles at 85 °C, capacitors meet the characteristics requirements listed below.				
	Capacitance change Dissipation factor Leakage current	Within ± 10 % of initial value Initial specified value or less Initial specified value or less			
Surge current	After subjecting parts in series with a 1 $\Omega$ resistor at the rate of 3 s CHARGE, 3 s DISCHARGE, and a cap bank of 100K $\mu$ F for 3 successive test cycles at 25 °C, capacitors meet the characteristics requirements listed below.				
	Capacitance change Dissipation factor Leakage current	Within $\pm$ 10 % of initial value Initial specified value or less Initial specified value or less			
Life test at + 85 °C	Capacitors meet the characteristic require	ments listed below. After 2000 h application of rated voltage at 85 °C.			
	Capacitance change Leakage current	Within $\pm$ 10 % of initial value Shall not exceed 125 % of initial value			
Life test at + 125 °C	Capacitors meet the characteristic requirements listed below. After 1000 h application 2/3 of rated voltage at 125 °C.				
	Capacitance change for parts with cap. ≤ 600 μF for parts with cap. > 600 μF Leakage current	Within $\pm$ 10 % of initial value Within $\pm$ 20 % of initial value Shall not exceed 125 % of initial value			

# **Typical Performance Characteristics**

Vishay Sprague

CAPACITOR ENVIR	CAPACITOR ENVIRONMENTAL CHARACTERISTICS				
ITEM	CONDITION	ENVIRONMENTAL CHARACTERISTICS			
Humidity tests	At 40 °C/90 % RH 1000 h, no voltage applied.	Capacitance change Cap. $\leq$ 600 µF Within $\pm$ 10 % of initial value Cap. $>$ 600 µF Within $\pm$ 20 % of initial value Not to exceed 150 % of initial + 25 °C requirement			
Temperature cycles	At - 55 °C/+ 125 °C, 30 min each, for 5 cycles.	Capacitance change Cap. $\leq$ 600 µF Within $\pm$ 10 % of initial value Cap. $>$ 600 µF Within $\pm$ 20 % of initial value Dissipation factor Leakage current Initial specified value or less Initial specified value or less			
Moisture resistance	MIL-STD-202, method 106 at rated voltage, 42 cycles.	Capacitance change Cap. $\leq$ 600 µF Within $\pm$ 10 % of initial value Cap. $>$ 600 µF Within $\pm$ 20 % of initial value Dissipation factor Leakage current Initial specified value or less Initial specified value or less			
Thermal shock	Capacitors are subjected to 5 cycles of the following: $-55^{\circ}\text{C} \ (+\ 0^{\circ}\text{C}, -5^{\circ}\text{C}) \ \text{for 30 min, then} \\ +\ 25^{\circ}\text{C} \ (+\ 10^{\circ}\text{C}, -5^{\circ}\text{C}) \ \text{for 5 min, then} \\ +\ 125^{\circ}\text{C} \ (+\ 3^{\circ}\text{C}, -0^{\circ}\text{C}) \ \text{for 30 min, then} \\ +\ 25^{\circ}\text{C} \ (+\ 10^{\circ}\text{C}, -5^{\circ}\text{C}) \ \text{for 5 min} \\ \end{cases}$	Capacitance change Cap. $\leq 600~\mu F$ Within $\pm 10~\%$ of initial value Cap. $> 600~\mu F$ Within $\pm 20~\%$ of initial value Dissipation factor Leakage current Initial specified value or less Initial specified value or less			

MECHANICAL PERFORMANCE CHARACTERISTICS				
TEST CONDITION	CONDITION	POST TEST PERFORMANCE		
Shear test	Apply a pressure load of 5 N for 10 s ± 1 s horizontally to the center of capacitor side body.	Capacitance change Dissipation factor Leakage current  Within ± 10 % of initial value Initial specified value or less Initial specified value or less		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Substrate bend	With parts soldered onto substrate test board, apply force to the test board for a deflection of 3 mm, for a total of 3 bends at a rate of 1 mm/s.	Capacitance change Dissipation factor Leakage current  Within ± 10 % of initial value Initial specified value or less Initial specified value or less		
Vibration	MIL-STD-202, method 204, condition D, 10 Hz to 2000 Hz, 20 <i>g</i> peak	Capacitance change Dissipation factor Leakage current  Within ± 10 % of initial value Initial specified value or less Initial specified value or less		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Shock	MIL-STD-202, method 213B shock (specified pulse), condition I, 100 g peak	Capacitance change Dissipation factor Leakage current  Within ± 10 % of initial value Initial specified value or less Initial specified value or less		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Resistance to solder heat	Recommended reflow profiles temperatures and durations are located within the Capacitor Series Guides	Capacitance change Dissipation factor Leakage current  Within ± 10 % of initial value Initial specified value or less Initial specified value or less		
	Pb-free and lead-bearing series caps are backward and forward compatible	There shall be no mechanical or visual damage to capacitors post-conditioning.		
Solderability	MIL-STD-2002, method 208, ANSI/J-STD-002, test B. Applies only to solder and tin plated terminations.	Capacitance change Dissipation factor Leakage current  Within ± 10 % of initial value Initial specified value or less Initial specified value or less		
	Does not apply to gold terminations.	There shall be no mechanical or visual damage to capacitors post-conditioning.		
Resistance to solvents	MIL-STD-202, method 215	Capacitance change Within ± 10 % of initial value Dissipation factor Initial specified value or less Leakage current Initial specified value or less		
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Flammability	Encapsulent materials meet UL 94 V-0 with an oxygen index of 32 %.			



### **Legal Disclaimer Notice**

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## **Mouser Electronics**

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